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## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Gerard Chauvel, et al.  
Serial No.: 10/632,228  
Filed: July 31, 2003  
For: System and Method to Automatically Stack and Unstack Java Local Variables

TI-35422

Art Unit: 2186

Examiner: Mano Padmanabhan

Conf. No.: 2073

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NAME OF INVENTOR(S):		
Gerard Chauvel, et al.		
TITLE OF INVENTION: System and Method to Automatically Stack and Unstack Java Local Variables		
TI FILE NO.:	DEPOSIT ACCT. NO.:	
TI-35422	20-0668	
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